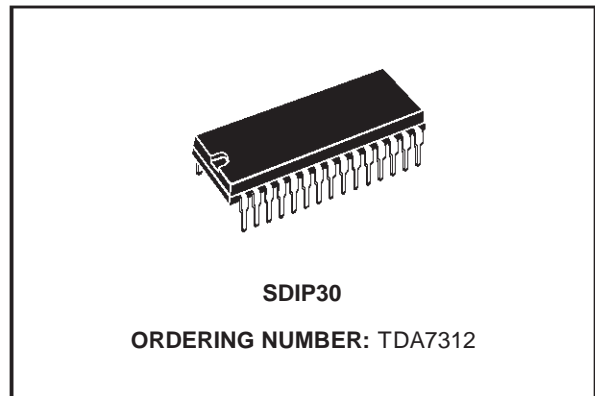




DIGITAL CONTROLLED STEREO AUDIO PROCESSOR

- INPUT MULTIPLEXER:
 - 4 STEREO INPUTS
- FOUR SELECTABLE ADDRESSES
- TWO DIGITAL CONTROL OUTPUTS
- INPUT AND OUTPUT FOR EXTERNAL EQUALIZER OR NOISE REDUCTION SYSTEM
- VOLUME CONTROL IN 1.25dB STEPS
- TREBLE AND BASS CONTROL
- TWO SPEAKER ATTENUATORS:
 - INDEPENDENT SPEAKERS CONTROL IN 1.25dB STEPS
 - INDEPENDENT MUTE FUNCTION
- ALL FUNCTIONS PROGRAMMABLE VIA SERIAL I²C BUS



DESCRIPTION

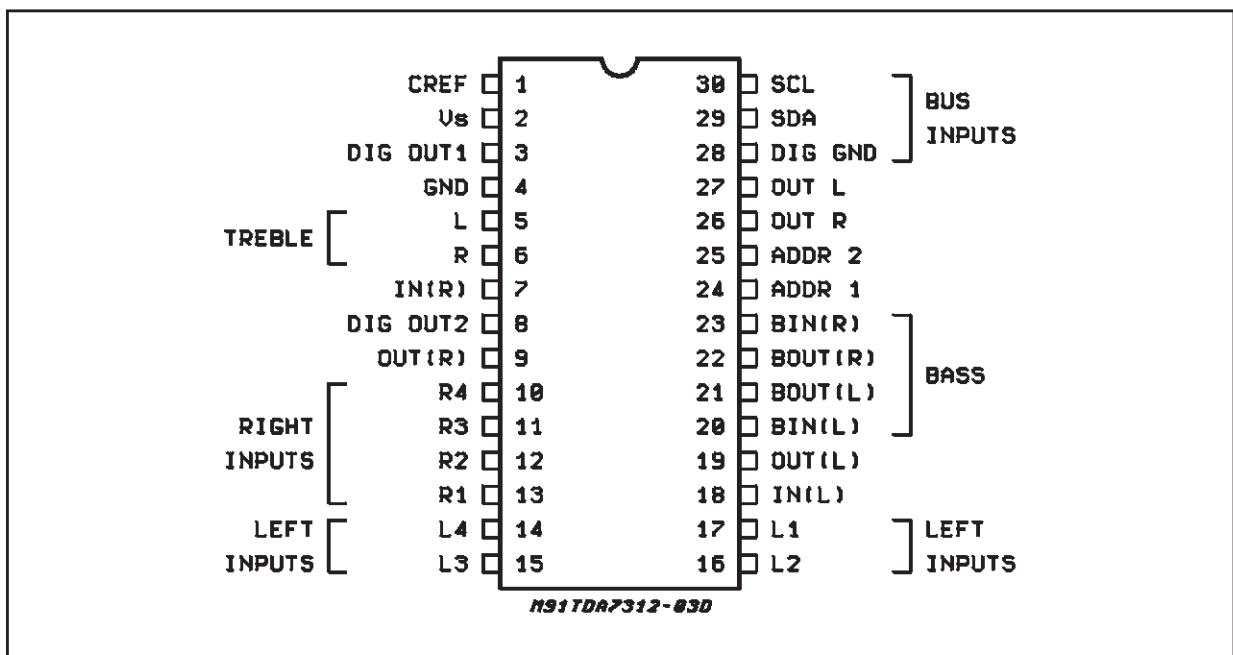
The TDA7312 is a volume, tone (bass and treble) balance (Left/Right) processor for quality audio applications.

Control is accomplished by serial I²C bus microprocessor interface.

The AC signal setting is obtained by resistor networks and switches combined with operational amplifiers.

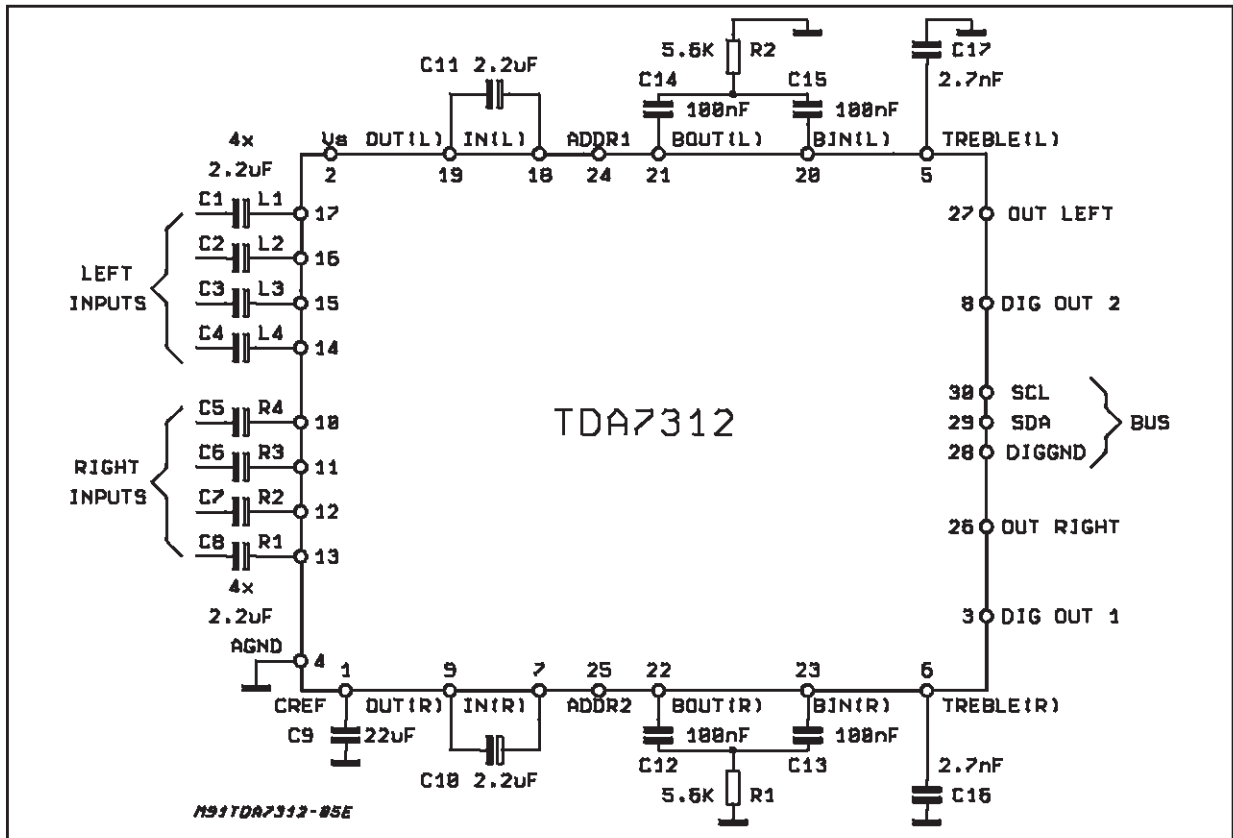
Thanks to the used BIPOLAR/CMOS Technology, Low Distortion, Low Noise and Low DC stepping are obtained.

PIN CONNECTION (Top view)



TDA7312

TEST CIRCUIT



THERMAL DATA

Symbol	Description	SDIP30	Unit
$R_{thj-pins}$	Thermal Resistance Junction-pins	max	85 °C/W

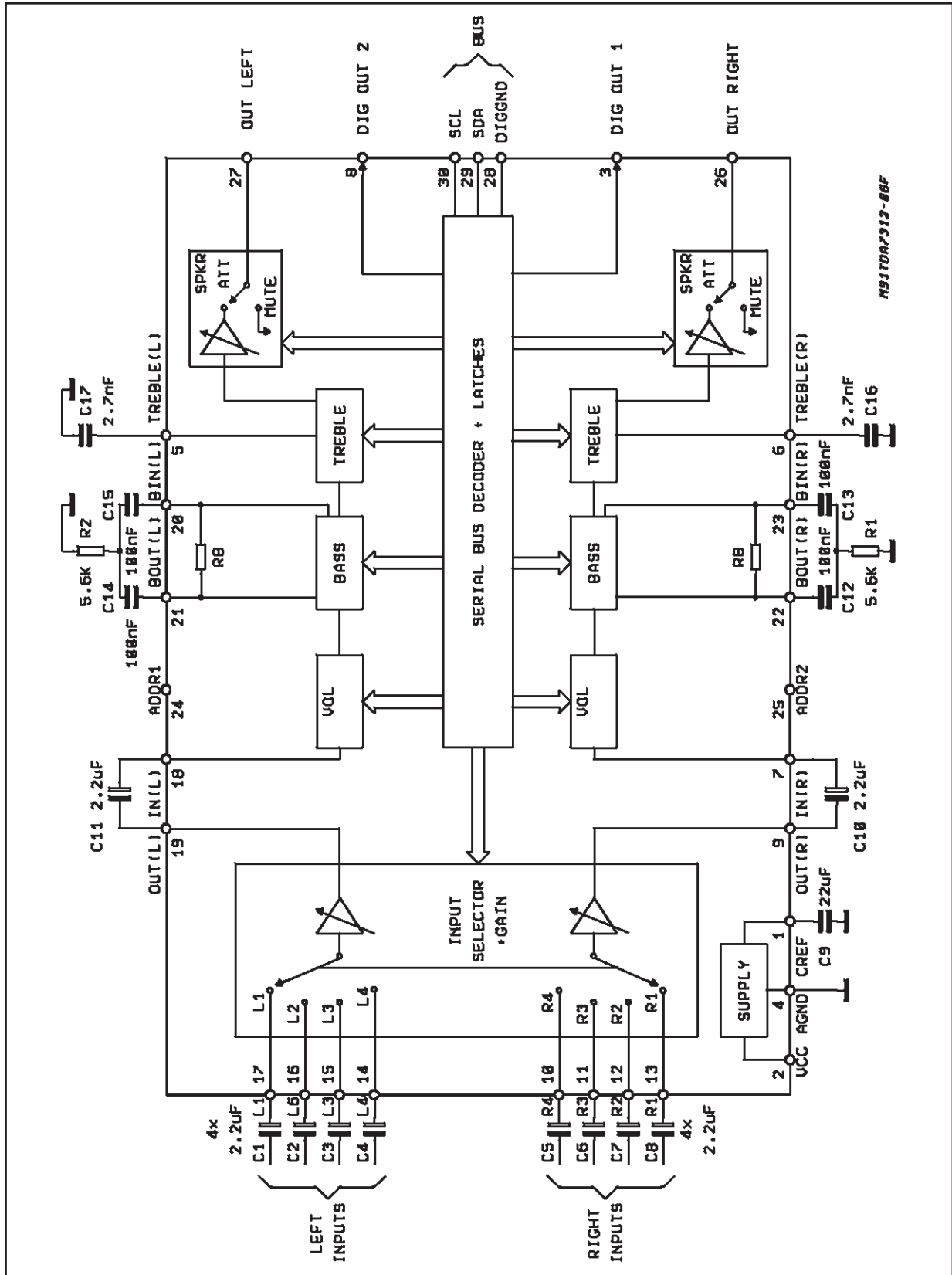
ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_S	Operating Supply Voltage	10.2	V
T_{amb}	Operating Ambient Temperature	0 to 70	°C
T_{stg}	Storage Temperature Range	-40 to 150	°C

QUICK REFERENCE DATA

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_S	Supply Voltage	6	9	10	V
V_{CL}	Max. input signal handling	2			V _{rms}
THD	Total Harmonic Distortion $V = 1V_{rms}$ $f = 1KHz$		0.01	0.1	%
S/N	Signal to Noise Ratio		106		dB
S_C	Channel Separation $f = 1KHz$		103		dB
	Volume Control 1.25dB step	-78.75		0	dB
	Bass and Treble Control 2db step	-14		+14	dB
	Fader and Balance Control 1.25dB step	-38.75		0	dB
	Mute Attenuation		100		dB

BLOCK DIAGRAM



MS10R7312-86F



TDA7312

ELECTRICAL CHARACTERISTICS (refer to the test circuit $T_{amb} = 25^{\circ}\text{C}$, $V_S = 9\text{V}$, $R_L = 10\text{K}\Omega$, $R_G = 600\Omega$, all controls flat ($G = 0$), $f = 1\text{KHz}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
--------	-----------	----------------	------	------	------	------

SUPPLY

V_S	Supply Voltage		6	9	10	V
I_S	Supply Current			8	11	mA
SVR	Ripple Rejection		60	80		dB

INPUT SELECTORS

R_{II}	Input Resistance	Input 1, 2, 3	35	50	70	$\text{K}\Omega$
V_{CL}	Clipping Level		2	2.5		V _{rms}
S_{IN}	Input Separation (2)		80	100		dB
R_L	Output Load resistance		2			$\text{K}\Omega$
e_{IN}	Input Noise			2		μV

VOLUME CONTROL

R_{IV}	Input Resistance		20	33	50	$\text{k}\Omega$
C_{RANGE}	Control Range		70	75	80	dB
A_{VMIN}	Min. Attenuation		-1	0	1	dB
A_{VMAX}	Max. Attenuation		70	75	80	dB
A_{STEP}	Step Resolution		0.5	1.25	1.75	dB
E_A	Attenuation Set Error	$A_v = 0$ to -20dB $A_v = -20$ to -60dB	-1.25 -3	0	1.25 2	dB dB
E_T	Tracking Error				2	dB
V_{DC}	DC Steps	adjacent attenuation steps From 0dB to A_v max		0 0.5	3 7.5	mV mV

SPEAKER ATTENUATORS

C_{range}	Control Range		35	37.5	40	dB
S_{STEP}	Step Resolution		0.5	1.25	1.75	dB
E_A	Attenuation set error				1.5	dB
A_{MUTE}	Output Mute Attenuation		80	100		dB
V_{DC}	DC Steps	adjacent att. steps from 0 to mute		0 1	3 10	mV mV

BASS CONTROL (1)

G_b	Control Range	Max. Boost/cut	± 12	± 14	± 16	dB
B_{STEP}	Step Resolution		1	2	3	dB
R_B	Internal Feedback Resistance		34	44	58	$\text{K}\Omega$

TREBLE CONTROL (1)

G_t	Control Range	Max. Boost/cut	± 13	± 14	± 15	dB
T_{STEP}	Step Resolution		1	2	3	dB

DIGITAL OUTPUTS

V_{CESAT}		$V_{OUT} = \text{Low } I_c = 1\text{mA}$		0.2	0.3	V
I_{leak}	I leakage	$V_{OUT} = V_S$			10	μA

ELECTRICAL CHARACTERISTICS (continued)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V _{OCL}	Clipping Level	d = 0.3%	2	2.5		V _{rms}
R _L	Output Load Resistance		2			KΩ
C _L	Output Load Capacitance				10	nF
R _{OUT}	Output resistance		30	75	120	Ω
V _{OUT}	DC Voltage Level		4.2	4.5	4.8	V

GENERAL

e _{NO}	Output Noise	BW = 20-20KHz, flat output muted all gains = 0dB		2.5 5	15	μV μV
		A curve all gains = 0dB		3		μV
S/N	Signal to Noise Ratio	all gains = 0dB; V _O = 1V _{rms}		106		dB
d	Distortion	A _V = 0, V _{IN} = 1V _{rms}		0.01	0.1	%
		A _V = -20dB V _{IN} = 1V _{rms}		0.09	0.3	%
		V _{IN} = 0.3V _{rms}		0.04		%
Sc	Channel Separation left/right		80	103		dB
	Total Tracking error	A _V = 0 to -20dB		0	1	dB
		-20 to -60 dB		0	2	dB

BUS INPUTS

V _{IL}	Input Low Voltage				1	V
V _{IH}	Input High Voltage		3			V
I _{IN}	Input Current		-5		+5	μA
V _O	Output Voltage SDA Acknowledge	I _O = 1.6mA			0.4	V

ADDRESS PIN (Internal 50KΩ pull down resistor).

Notes:

SDA, SCL, DIG OUT 1, DIG OUT 2 Pins are high impedance when V_s = 0

(1) Bass and Treble response see attached diagram (fig.16). The center frequency and quality of the resonance behaviour can be chosen by the external circuitry. A standard first order bass response can be realized by a standard feedback network

(2) The selected input is grounded thru the 2.2μF capacitor.

Figure 1: Noise vs. Volume/Gain Settings

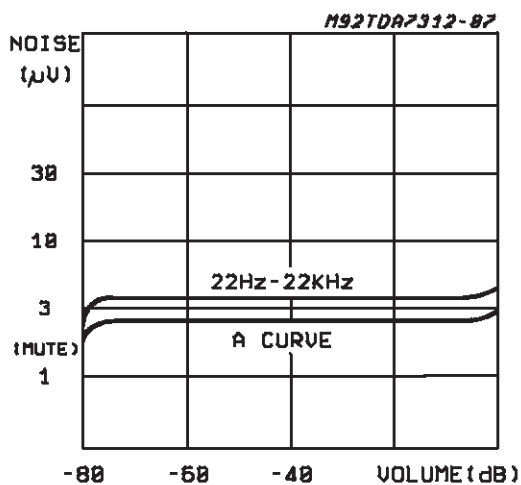


Figure 2: Signal to Noise Ratio vs. Volume Setting

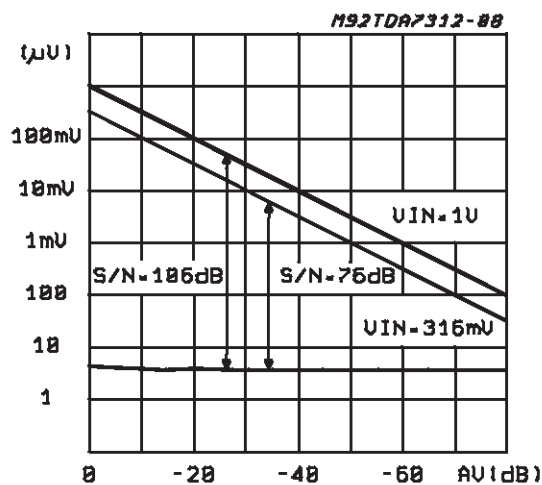


Figure 3: Distortion & Noise vs. Frequency

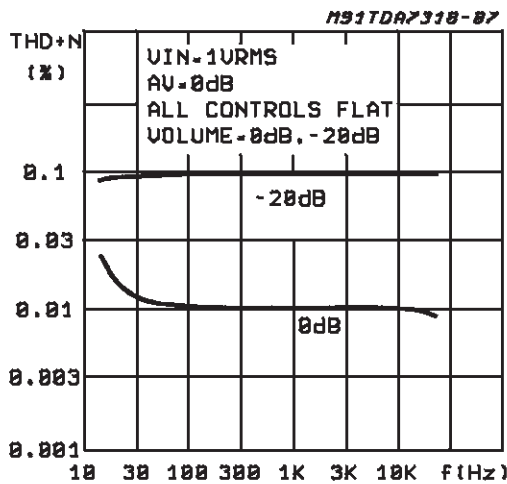


Figure 4: Distortion & Noise vs. Frequency

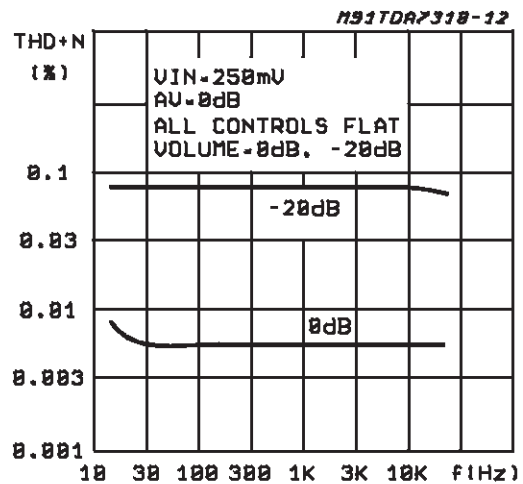


Figure 5: Distortion vs. Load Resistance

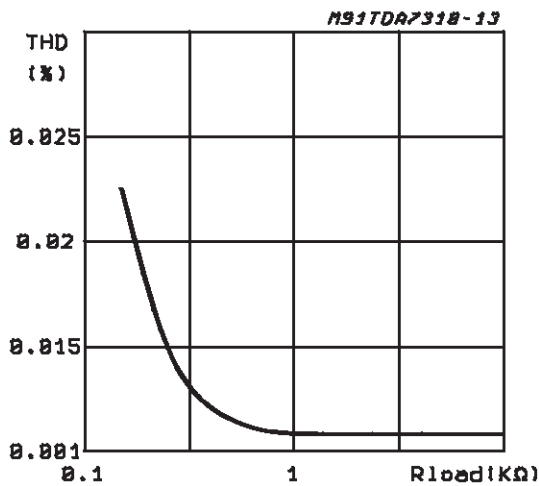


Figure 6: Channel Separation (L → R) vs. Frequency

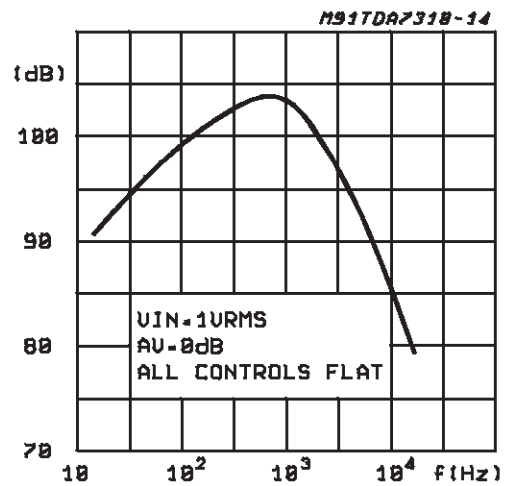


Figure 7: Input Separation (L1 → L2, L3, L4) vs. Frequency

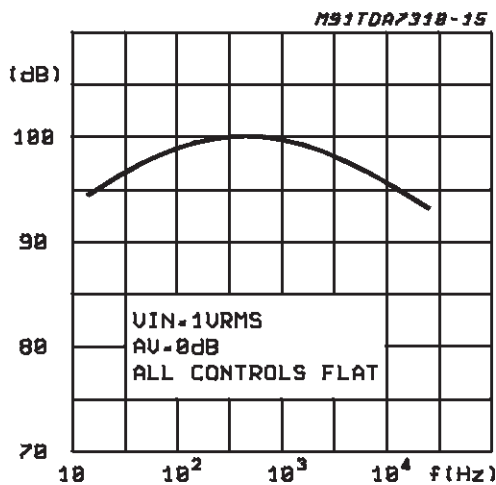


Figure 8: Supply Voltage Rejection vs. Frequency

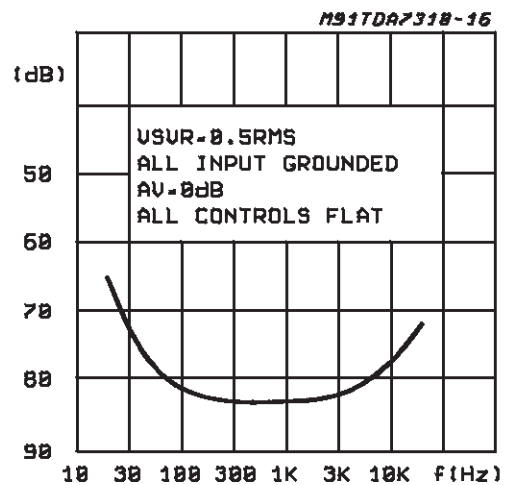


Figure 9: Output Clipping Level vs. Supply Voltage

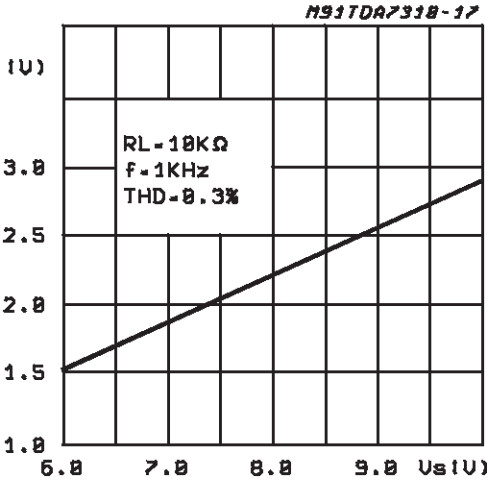


Figure 10: Quiescent Current vs. Supply Voltage

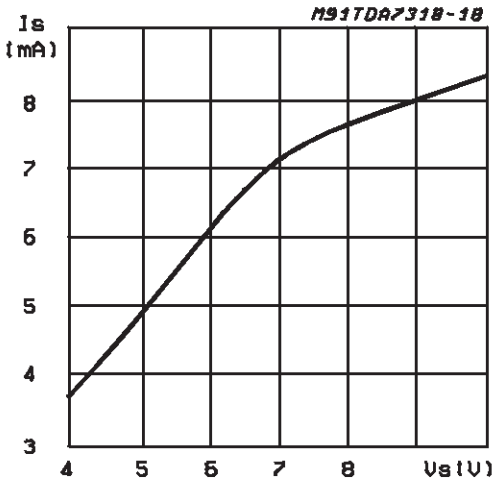


Figure 11: Supply Current vs. Temperature

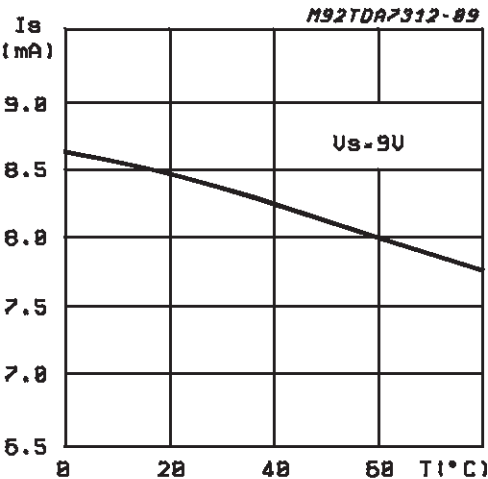


Figure 12: Bass Resistance vs. Temperature

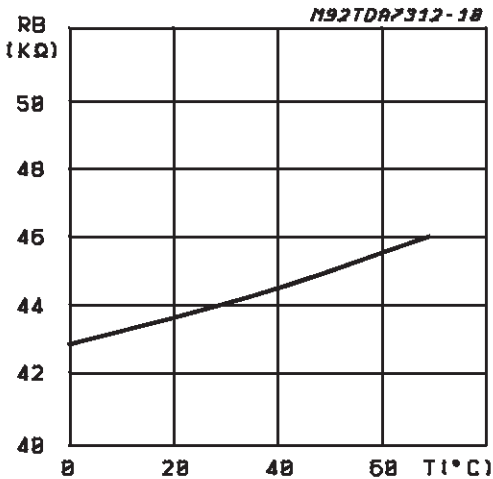
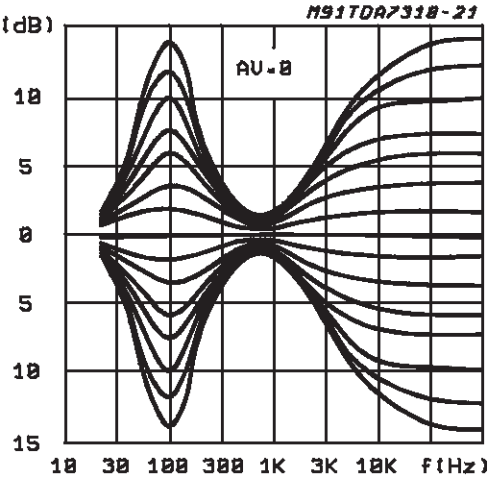


Figure 13: Typical Tone Response (with the ext. components indicated in the test circuit)



I²C BUS INTERFACE

Data transmission from microprocessor to the TDA7312 and viceversa takes place thru the 2 wires I²C BUS interface, consisting of the two lines SDA and SCL (pull-up resistors to positive supply voltage must be connected).

Data Validity

As shown in fig. 14, the data on the SDA line must be stable during the high period of the clock. The HIGH and LOW state of the data line can only change when the clock signal on the SCL line is LOW.

Start and Stop Conditions

As shown in fig.15 a start condition is a HIGH to LOW transition of the SDA line while SCL is HIGH. The stop condition is a LOW to HIGH transition of the SDA line while SCL is HIGH.

Byte Format

Every byte transferred on the SDA line must contain 8 bits. Each byte must be followed by an ac-

knowledge bit. The MSB is transferred first.

Acknowledge

The master (μ P) puts a resistive HIGH level on the SDA line during the acknowledge clock pulse (see fig. 16). The peripheral (audioprocessor) that acknowledges has to pull-down (LOW) the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during this clock pulse.

The audioprocessor which has been addressed has to generate an acknowledge after the reception of each byte, otherwise the SDA line remains at the HIGH level during the ninth clock pulse time. In this case the master transmitter can generate the STOP information in order to abort the transfer.

Transmission without Acknowledge

Avoiding to detect the acknowledge of the audioprocessor, the μ P can use a simpler transmission: simply it waits one clock without checking the slave acknowledging, and sends the new data.

This approach of course is less protected from misworking and decreases the noise immunity.

Figure 14: Data Validity on the I²CBUS

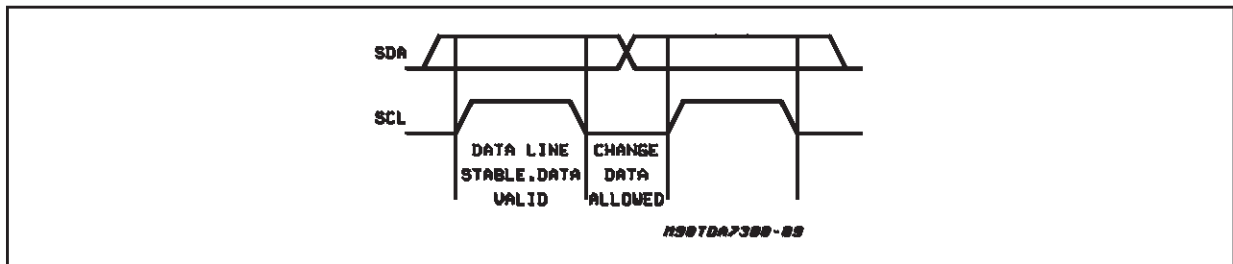


Figure 15: Timing Diagram of I²CBUS

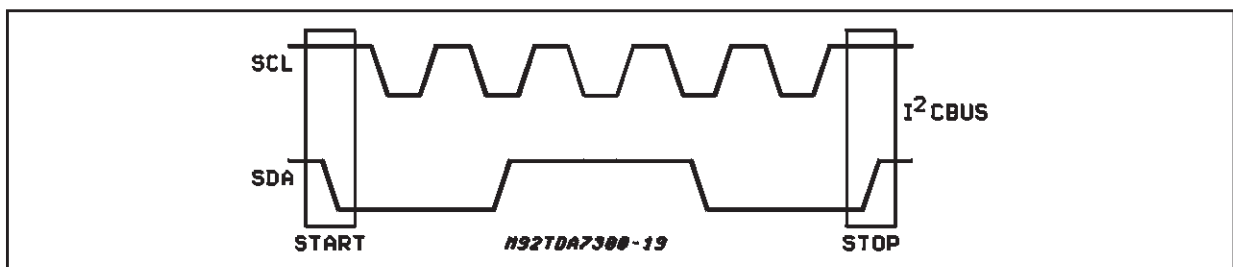
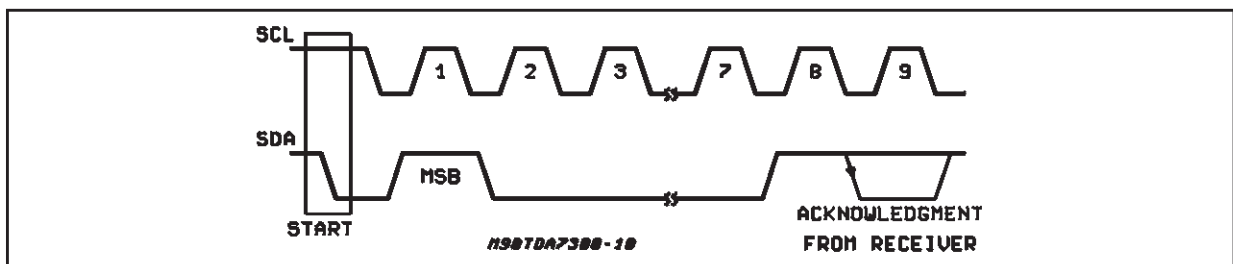


Figure 16: Acknowledge on the I²CBUS



SOFTWARE SPECIFICATION

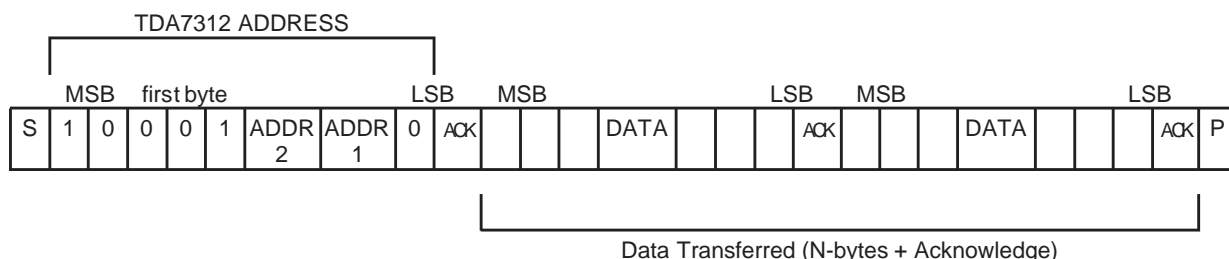
Interface Protocol

The interface protocol comprises:

- A start condition (s)
- A chip address byte, containing the TDA7312

address (the 8th bit of the byte must be 0). The TDA7312 must always acknowledge at the end of each transmitted byte.

- A sequence of data (N-bytes + acknowledge)
- A stop condition (P)



ACK = Acknowledge
 S = Start
 P = Stop

SOFTWARE SPECIFICATION

Chip address

1	0	0	0	1	ADDR 2	ADDR 1	0
MSB							LSB

ADDR2	ADDR1	CHIP ADDRESS
0	0	88 HEX
0	1	8A HEX
1	0	8C HEX
1	1	8E HEX

DATA BYTES

MSB					LSB			FUNCTION
0	0	B2	B1	B0	A2	A1	A0	Volume control
1	0	0	B1	B0	A2	A1	A0	Speaker ATT L
1	0	1	B1	B0	A2	A1	A0	Speaker ATT R
0	1	0	D2	D1	S2	S1	S0	Audio switch
0	1	1	0	C3	C2	C1	C0	Bass control
0	1	1	1	C3	C2	C1	C0	Treble control

Ax = 1.25dB steps; Bx = 10dB steps; Cx = 2dB steps; Sx = Input Selector; Dx = Dig Out Pins

SOFTWARE SPECIFICATION (continued)

DATA BYTES (detailed description)

Volume

MSB				LSB			FUNCTION	
0	0	B2	B1	B0	A2	A1	A0	Volume 1.25dB steps
					0	0	0	0
					0	0	1	-1.25
					0	1	0	-2.5
					0	1	1	-3.75
					1	0	0	-5
					1	0	1	-6.25
					1	1	0	-7.5
					1	1	1	-8.75
0	0	B2	B1	B0	A2	A1	A0	Volume 10dB steps
		0	0	0				0
		0	0	1				-10
		0	1	0				-20
		0	1	1				-30
		1	0	0				-40
		1	0	1				-50
		1	1	0				-60
		1	1	1				-70

For example a volume of -45dB is given by:

0 0 1 0 0 1 0 0

Speaker Attenuators

MSB				LSB			FUNCTION	
1	0	0	B1	B0	A2	A1	A0	Speaker L
1	0	1	B1	B0	A2	A1	A0	Speaker R
					0	0	0	0
					0	0	1	-1.25
					0	1	0	-2.5
					0	1	1	-3.75
					1	0	0	-5
					1	0	1	-6.25
					1	1	0	-7.5
					1	1	1	-8.75
		0	0					0
		0	1					-10
		1	0					-20
		1	1					-30
		1	1	1	1	1	1	Mute

For example attenuation of 25dB on speaker R is given by:

1 0 1 1 0 1 0 0

Audio Switch

MSB			LSB					FUNCTION
0	1	0	D2	D1	S2	S1	S0	Audio Switch
					1	0	0	Stereo 1
					1	0	1	Stereo 2
					1	1	0	Stereo 3
					1	1	1	Stereo 4
				0				DIG. OUT 1 = 0
				1				DIG. OUT 1 = 1
		0						DIG. OUT 2 = 0
		1						DIG. OUT 2 = 1

Bass and Treble

0	1	1	0	C3	C2	C1	C0	Bass
0	1	1	1	C3	C2	C1	C0	Treble
				0	0	0	0	-14
				0	0	0	1	-12
				0	0	1	0	-10
				0	0	1	1	-8
				0	1	0	0	-6
				0	1	0	1	-4
				0	1	1	0	-2
				0	1	1	1	0
				1	1	1	1	0
				1	1	1	0	2
				1	1	0	1	4
				1	1	0	0	6
				1	0	1	1	8
				1	0	1	0	10
				1	0	0	1	12
				1	0	0	0	14

C3 = Sign

For example Bass at -10dB is obtained by the following 8 bit string:

0 1 1 0 0 0 1 0

Status at Power on Reset

Volume = 78.75dB

Treble = Bass = +2dB

Spkrs Attenuators = Mute

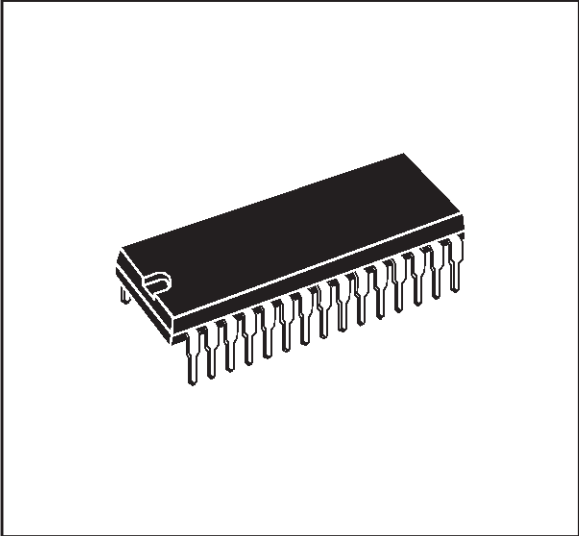
Input = Stereo 1

Dig. OUT 1 = Dig. OUT 2 = 1

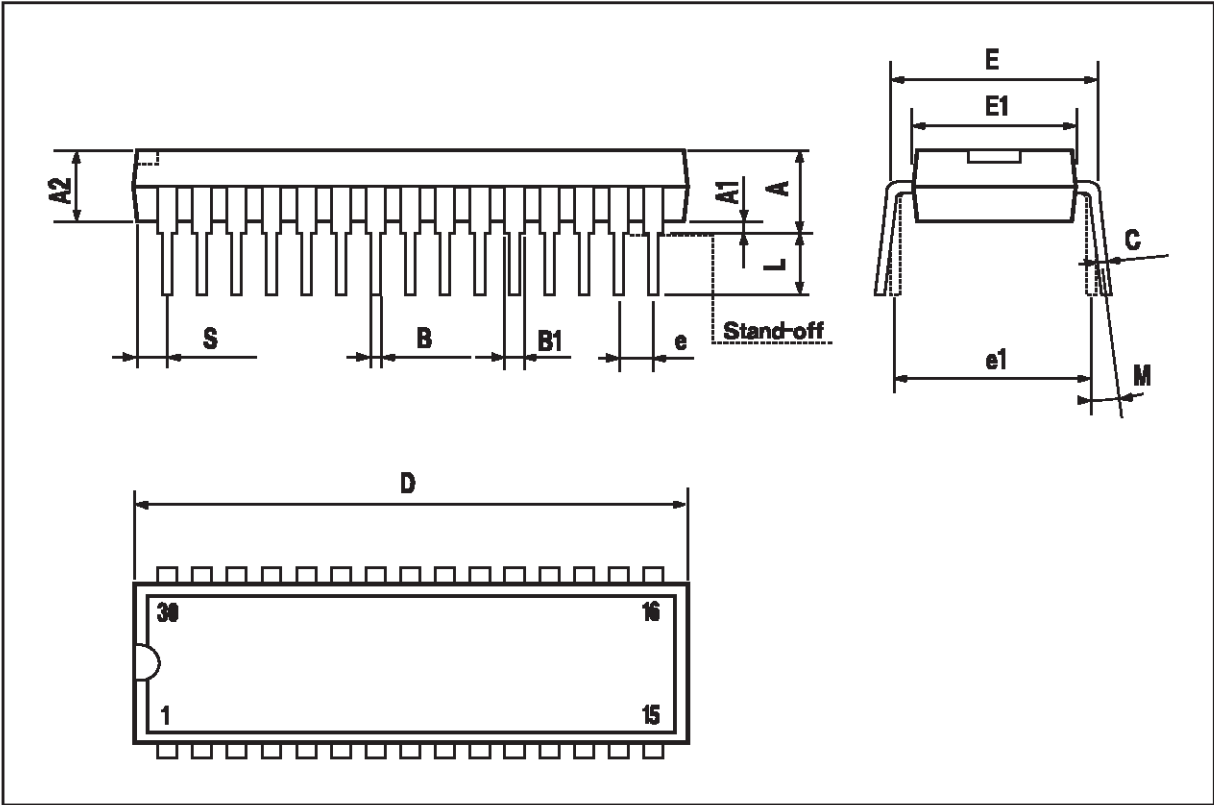
TDA7312

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			5.08			0.20
A1	0.51			0.020		
A2	3.05	3.81	4.57	0.12	0.15	0.18
B	0.36	0.46	0.56	0.014	0.018	0.022
B1	0.76	0.99	1.40	0.030	0.039	0.055
C	0.20	0.25	0.36	0.008	0.01	0.014
D	27.43	27.94	28.45	1.08	1.10	1.12
E	10.16	10.41	11.05	0.400	0.410	0.435
E1	8.38	8.64	9.40	0.330	0.340	0.370
e		1.778			0.070	
e1		10.16			0.400	
L	2.54	3.30	3.81	0.10	0.13	0.15
M	0°(min.), 15°(max.)					
S	0.31			0.012		

OUTLINE AND MECHANICAL DATA



SDIP30 (0.400")



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